12-stage shift-and-store register LED driver Rev. 8 — 22 November 2011

Product data sheet

1. **General description**

The HEF4894B is a 12-stage serial shift register. It has a storage latch associated with each stage for strobing data from the serial input (D) to the parallel LED driver outputs (QP0 to QP11). Data is shifted on positive-going clock (CP) transitions. The data in each shift register stage is transferred to the storage register when the strobe (STR) input is HIGH. Data in the storage register appears at the output whenever the output enable (OE) input signal is HIGH.

Two serial outputs (QS1 and QS2) are available for cascading a number of HEF4894B devices. Serial data is available at QS1 on positive-going clock edges to allow high-speed operation in cascaded systems with a fast clock rise time. The same serial data is available at QS2 on the next negative going clock edge. This is used for cascading HEF4894B devices when the clock has a slow rise time.

It operates over a recommended V_{DD} power supply range of 3 V to 15 V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD}, V_{SS}, or another input.

Features and benefits 2.

	Fully	static	operation
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- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from -40 °C to +85 °C and -40 °C to +125 °C
- Complies with JEDEC standard JESD 13-B

3. Ordering information

Table 1. **Ordering information**

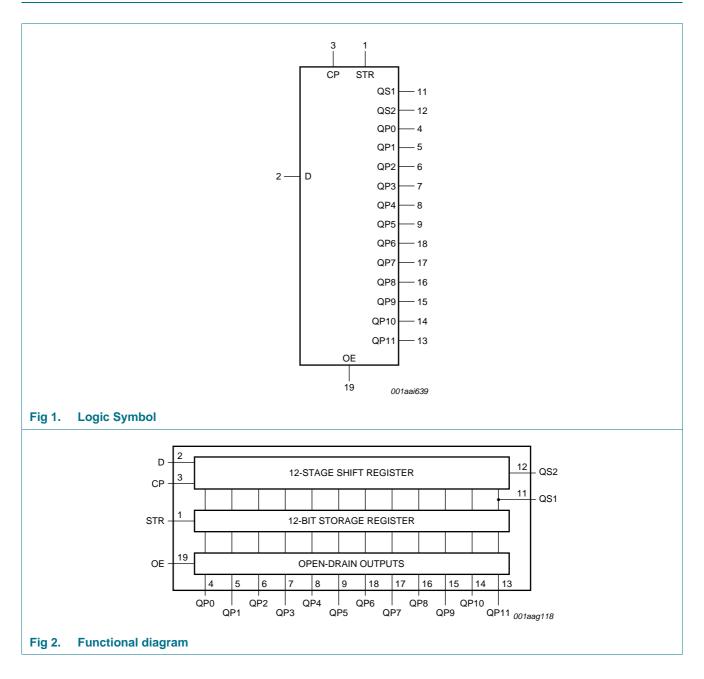
All types operate from -40 °C to +125 °C.

Type number	Package	Package						
	Name	Description	Version					
HEF4894BP	DIP20	plastic dual in-line package; 20 leads (300 mil)	SOT146-1					
HEF4894BT	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1					
HEF4894BTT	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1					

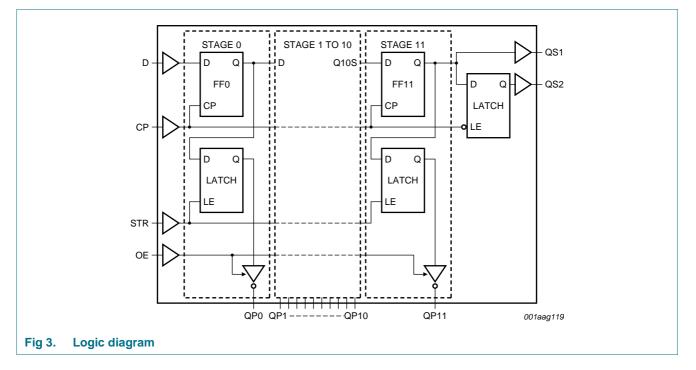


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4. Functional diagram

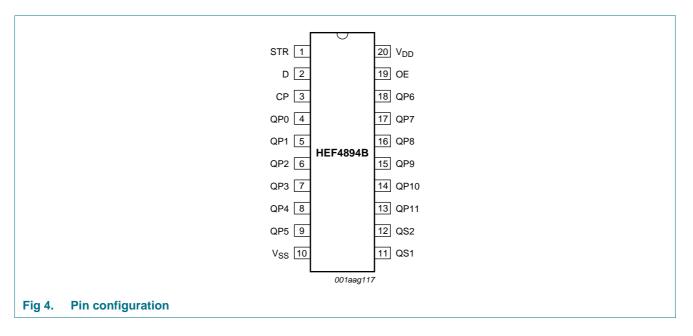


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5. Pinning information

5.1 Pinning



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5.2 Pin description

Table 2. Pin description										
Symbol	Pin	Description								
D	2	serial input								
QP0 to QP11	4, 5, 6, 7, 8, 9, 18, 17, 16, 15, 14, 13	parallel output								
QS1	11	serial output								
QS2	12	serial output								
СР	3	clock input								
STR	1	strobe input								
OE	19	output enable input								
V _{DD}	20	supply voltage								
V _{SS}	10	ground (0 V)								

6. Functional description

Table 3.Function table^[1]

At the positive clock edge the information in the 10th register stage is transferred to the 11th register stage and the QS output

Control		Input	Parallel out	Parallel output		Serial output		
СР	OE	STR	D	QP0	QPn	QS1 ^[2]	QS2 ^[3]	
\uparrow	L	Х	Х	Z	Z	Q10S	no change	
\downarrow	L	Х	Х	Z	Z	no change	Q11S	
\uparrow	Н	L	Х	no change	no change	Q10S	no change	
\uparrow	Н	Н	L	Z	QPn – 1	Q10S	no change	
\uparrow	Н	Н	Н	L	QPn – 1	Q10S	no change	
\downarrow	Н	Н	Н	no change	no change	no change	Q11S	

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; ↑ = LOW-to-HIGH clock transition; ↓ = HIGH-to-LOW clock transition; Z = high-impedance OFF-state.

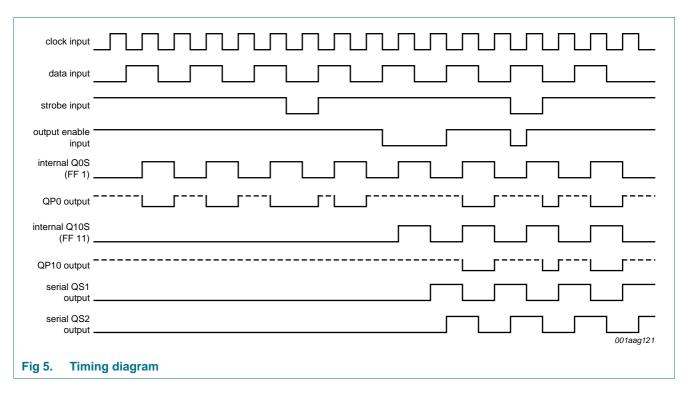
[2] Q10S = the data in register stage 10 before the LOW to HIGH clock transition.

[3] Q11S = the data in register stage 11 before the HIGH to LOW clock transition.

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7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DD}	supply voltage		-0.5	+18	V
l _{IK}	input clamping current	$V_{I} < -0.5$ V or $V_{I} > V_{DD}$ + 0.5 V	-	±10	mA
VI	input voltage		-0.5	V _{DD} + 0.5	V
l _{ок}	output clamping current	QSn outputs; V _O < –0.5 V or V _O > V _{DD} + 0.5 V	-	±10	mA
		QPn outputs; $V_0 < 0.5 V$	-	40	mA
l _l	input leakage current		-	±10	mA
lo	output current	QSn outputs	-	±10	mA
		QPn outputs	-	40	mA
T _{stg}	storage temperature		-65	+150	°C
T _{amb}	ambient temperature		-40	+125	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to +125 \ ^{\circ}C$			
		DIP20 package	<u>[1]</u> _	750	mW
		SO20 package	[2] _	500	mW
		TSSOP20 package	[3] _	500	mW
Р	power dissipation	per output	-	100	mW

[1] For DIP20 package: P_{tot} derates linearly with 12 mW/K above 70 °C.

[2] For SO20 package: P_{tot} derates linearly with 8 mW/K above 70 $^\circ C.$

[3] For TSSOP20 package: Ptot derates linearly with 5.5 mW/K above 60 °C.

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8. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DD}	supply voltage		3	-	15	V
VI	input voltage		0	-	V_{DD}	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{DD} = 5 V$	-	-	3.75	μs/V
		V _{DD} = 10 V	-	-	0.5	μs/V
		V _{DD} = 15 V	-	-	0.08	μs/V

9. Static characteristics

Table 6. Static characteristics

 $V_{SS} = 0$ V; $V_l = V_{SS}$ or V_{DD} ; unless otherwise specified.

Symbol	Parameter	Conditions	V _{DD}	T _{amb} =	–40 °C	T _{amb} =	+25 °C	T _{amb} =	+85 °C	T _{amb} = -	+125 °C	Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
V _{IH}	HIGH-level	I _O < 1 μA	5 V	3.5	-	3.5	-	3.5	-	3.5	-	V
	input voltage		10 V	7.0	-	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	11.0	-	V
V _{IL}	LOW-level	$ I_0 < 1 \ \mu A$	5 V	-	1.5	-	1.5	-	1.5	-	1.5	V
	input voltage		10 V	-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	-	4.0	V
V _{OH}	HIGH-level	QSn outputs;	5 V	4.95	-	4.95	-	4.95	-	4.95	-	V
	output voltage	I _O < 1 μA	10 V	9.95	-	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	14.95	-	V
V _{OL}	V _{OL} LOW-level output voltage	· ·	5 V	-	0.05	-	0.05	-	0.05	-	0.05	V
			10 V	-	0.05	-	0.05	-	0.05	-	0.05	V
			15 V	-	0.05	-	0.05	-	0.05	-	0.05	V
		QPn outputs;	5 V	-	0.75	-	0.75	-	1.5	-	1.5	V
		I _O < 20 mA	10 V	-	0.75	-	0.75	-	1.5	-	1.5	V
			15 V	-	0.75	-	0.75	-	1.5	-	1.5	V
I _{OH}	HIGH-level	QSn outputs										
	output current	$V_{0} = 2.5 V$	5 V	-	-1.7	-	-1.4	-	-1.1	-	-1.1	mA
		$V_{0} = 4.6 V$	5 V	-	-0.64	-	-0.5	-	-0.36	-	-0.36	mA
		$V_{O} = 9.5 V$	10 V	-	-1.6	-	-1.3	-	-0.9	-	-0.9	mA
		V _O = 13.5 V	15 V	-	-4.2	-	-3.4	-	-2.4	-	-2.4	mA
I _{OL}	LOW-level	QSn outputs										
	output current	$V_{O} = 0.4 V$	5 V	0.64	-	0.5	-	0.36	-	0.36	-	mA
		$V_{O} = 0.5 V$	10 V	1.6	-	1.3	-	0.9	-	0.9	-	mA
		V _O = 1.5 V	15 V	4.2	-	3.2	-	2.4	-	2.4	-	mA
lı	input leakage current		15 V	-	±0.1	-	±0.1	-	±1.0	-	±1.0	μΑ

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Symbol	ymbol Parameter Conditions	Conditions	V _{DD}	T _{amb} =	−40 °C	T _{amb} =	+25 °C	T _{amb} =	+85 °C	T _{amb} = -	+125 °C	Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
I _{OZ} OFF-state	QPn output	5 V	-	2	-	2	-	15	-	15	μA	
	output current	is HIGH; V _O = 15 V	10 V	-	2	-	2	-	15	-	15	μA
			15 V	-	2	-	2	-	15	-	15	μA
I _{DD}	supply current	I _O = 0 A	5 V	-	5	-	5	-	150	-	150	μA
			10 V	-	10	-	10	-	300	-	300	μA
			15 V	-	20	-	20	-	600	-	600	μA
CI	input capacitance		-	-	-	-	7.5	-	-	-	-	pF

Table 6. Static characteristics ...continued

 $V_{SS} = 0$ V; $V_{I} = V_{SS}$ or V_{DD} ; unless otherwise specified.

10. Dynamic characteristics

Table 7. Dynamic characteristics

 $V_{SS} = 0 V$; $T_{amb} = 25$ °C unless otherwise specified. For test circuit see <u>Figure 10</u>.

Symbol	Parameter	Conditions	V_{DD}	Extrapolation formula	Min	Тур	Мах	Unit
t _{PHL}	HIGH to LOW	CP to QS1;	5 V	132 ns + (0.55 ns/pF)CL	-	160	320	ns
	propagation delay	see Figure 6	10 V	53 ns + (0.23 ns/pF)C _L	-	65	130	ns
			15 V	37 ns + (0.16 ns/pF)C _L	-	45	90	ns
		CP to QS2;	5 V	92 ns + (0.55 ns/pF)C _L	-	120	240	ns
		see Figure 6	10 V	39 ns + (0.23 ns/pF)C _L	-	50	100	ns
			15 V	32 ns + (0.16 ns/pF)C _L	-	40	80	ns
t _{PLH}	LOW to HIGH	CP to QS1; see <u>Figure 6</u>	5 V	[1] 102 ns + (0.55 ns/pF)C _L	-	130	260	ns
	propagation delay		10 V	44 ns + (0.23 ns/pF)C _L	-	55	110	ns
			15 V	32 ns + (0.16 ns/pF)C _L	-	40	80	ns
		CP to QS2; see <u>Figure 6</u>	5 V	102 ns + (0.55 ns/pF)C _L	-	130	260	ns
			10 V	49 ns + (0.23 ns/pF)C _L	-	60	120	ns
			15 V	37 ns + (0.16 ns/pF)C _L	-	45	90	ns
t _{PZL}	OFF-state to LOW	CP to QPn;	5 V		-	240	480	ns
	propagation delay	see Figure 6	10 V		-	80	160	ns
			15 V		-	55	110	ns
		STR to QPn;	5 V		-	140	280	ns
		see Figure 7	10 V		-	70	140	ns
			15 V		-	55	110	ns
t _{PLZ}	LOW to OFF-state	CP to QPn;	5 V		-	170	340	ns
	propagation delay	see Figure 6 and 7	10 V		-	75	150	ns
			15 V		-	60	120	ns
		STR to QPn;	5 V		-	100	200	ns
		see Figure 7	10 V		-	40	100	ns
			15 V		-	35	70	ns

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Symbol	Parameter	Conditions	V_{DD}		Extrapolation formula	Min	Тур	Max	Unit
t _{en}		OE to QPn;	5 V	[2]		-	100	200	ns
		see Figure 8	10 V			-	55	110	ns
			15 V			-	50	100	ns
dis		OE to QPn; see <u>Figure 8</u>	5 V	[2]		-	80	160	ns
			10 V			-	40	80	ns
			15 V			-	30	60	ns
t	transition time	e QS1, QS2; see <u>Figure 6</u>	5 V	[1][3]	35 ns + (1.00 ns/pF)C _L	-	85	170	ns
			10 V		19 ns + (0.42 ns/pF)C _L	-	40	80	ns
			15 V		16 ns + (0.28 ns/pF)C _L	-	30	60	ns
W	pulse width	CP; LOW and HIGH;	5 V			60	30	-	ns
		see <u>Figure 6</u>	10 V			30	15	-	ns
			15 V			24	12	-	ns
		STR; HIGH; see <u>Figure 7</u>	5 V			80	40	-	ns
			10 V			60	30	-	ns
			15 V			24	12	-	ns
su	set-up time	D to CP;	5 V			60	30	-	ns
		see <u>Figure 9</u>	10 V			20	10	-	ns
			15 V			15	5	-	ns
h	hold time	D to CP;	5 V			+5	–15	-	ns
		see Figure 9	10 V			20	5	-	ns
			15 V			20	5	-	ns
: clk(max)	maximum clock	CP; see Figure 6	5 V			5	10	-	MHz
	frequency		10 V			11	22	-	MHz
			15 V			14	28	-	MHz

Table 7. Dynamic characteristics ... continued

25 °C unless otherwise specified. For test circuit see Figure 10

[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C_L in pF).

[2] t_{en} is the same as t_{PZL} and t_{dis} is the same as t_{PLZ} .

[3] t_t is the same as t_{TLH} and t_{THL} .

Dynamic power dissipation Table 8.

P_D can be calculated from the formulas shown.	$V_{SS} = 0$ V; $t_r = t_f \le 20$ ns; $T_{amb} = 25$ °C.
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Symbol	Parameter	V_{DD}	Typical formula	Where	
P _D dynamic power		5 V	$\label{eq:posterior} \textbf{P}_{D} = \textbf{1200} \times \textbf{f}_{i} + \boldsymbol{\Sigma}(\textbf{f}_{o} \times \textbf{C}_{L}) \times \textbf{V}_{DD}{}^{2} \; \mu \textbf{W}$	$f_i = input frequency in MHz;$	
	dissipation	10 V	$P_D = 5550 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2 \ \mu W$	$f_0 = $ output frequency in MHz;	
		15 V	$P_D = 15000 \times f_i + \Sigma(f_o \times C_L) \times V_DD{}^2 \ \muW$	$\label{eq:logical_state} \begin{split} &-C_L = \text{output load capacitance in pF};\\ &\Sigma(f_o \times C_L) = \text{sum of the outputs};\\ &V_{DD} = \text{supply voltage in V}. \end{split}$	

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11. Waveforms

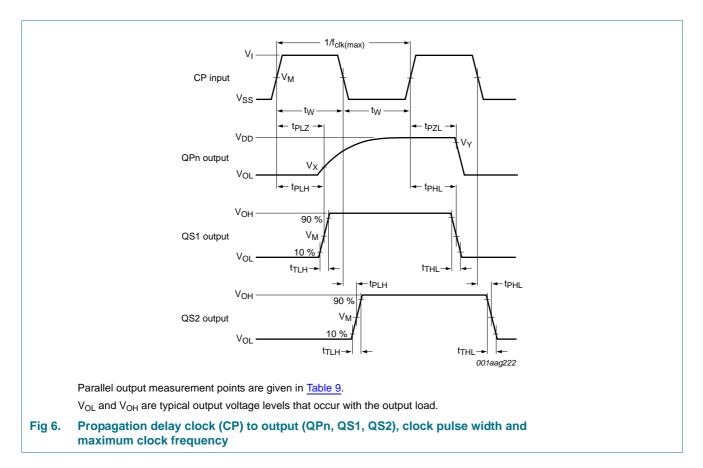
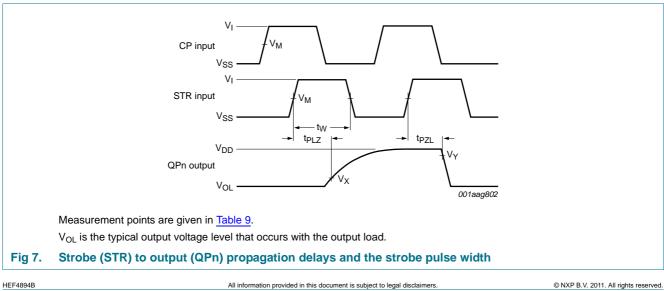


Table 9. Measurement points

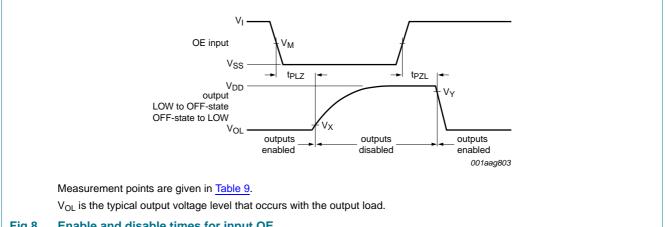
Supply	Input	Output		
V _{DD}	V _M	V _M	V _X	V _Y
5 V to 15 V	0.5V _{DD}	0.5V _{DD}	0.1V _O	0.9V _O



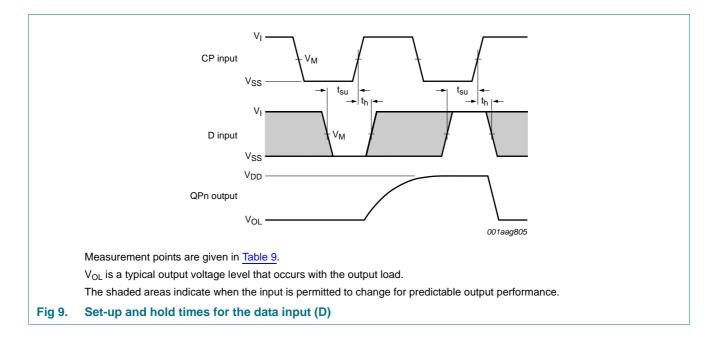
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Enable and disable times for input OE Fig 8.



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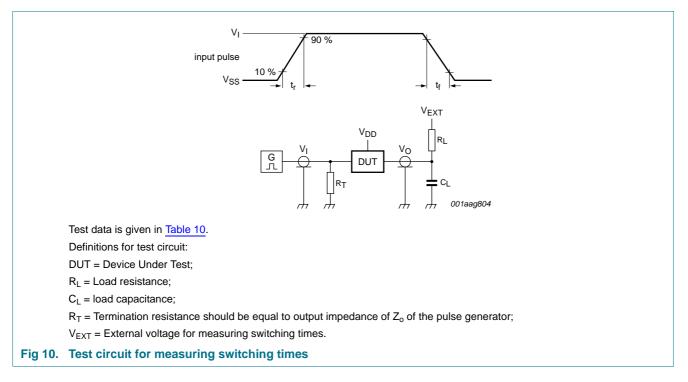
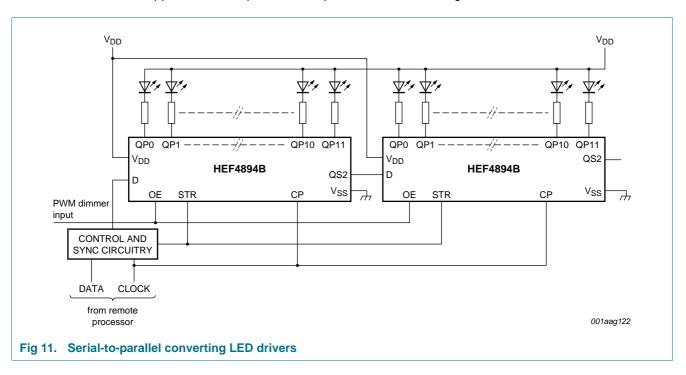


Table 10. Test data

Supply	Input		V _{EXT}		Load	
V _{DD}	VI	t _r , t _f	t _{PLZ} , t _{PZL}	t _{PLH} , t _{PHL}	CL	R _L
5 V to 15 V	V _{DD}	\leq 20 ns	V _{DD}	open	50 pF	1 kΩ

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12. Application information



Application example: serial-to-parallel data converting LED driver.

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13. Package outline

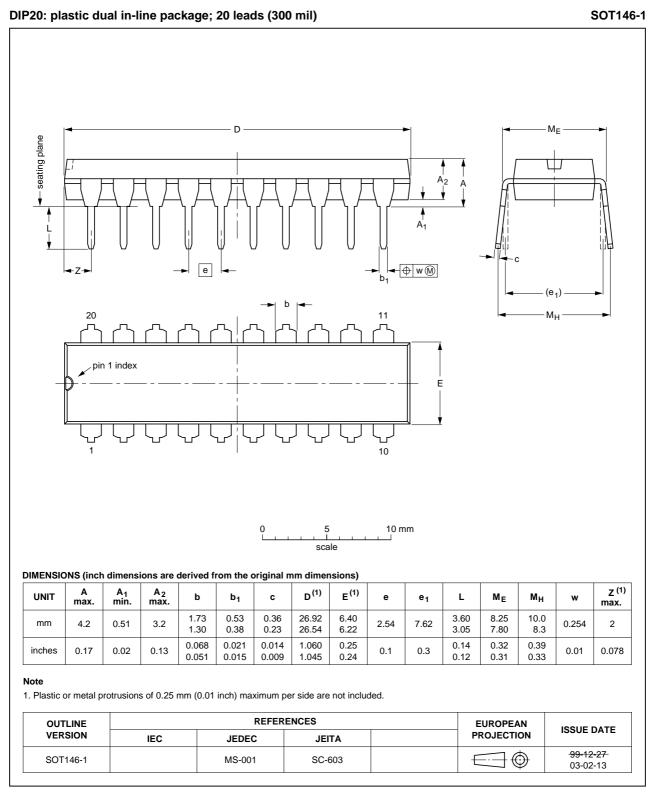


Fig 12. Package outline SOT146-1 (DIP20)

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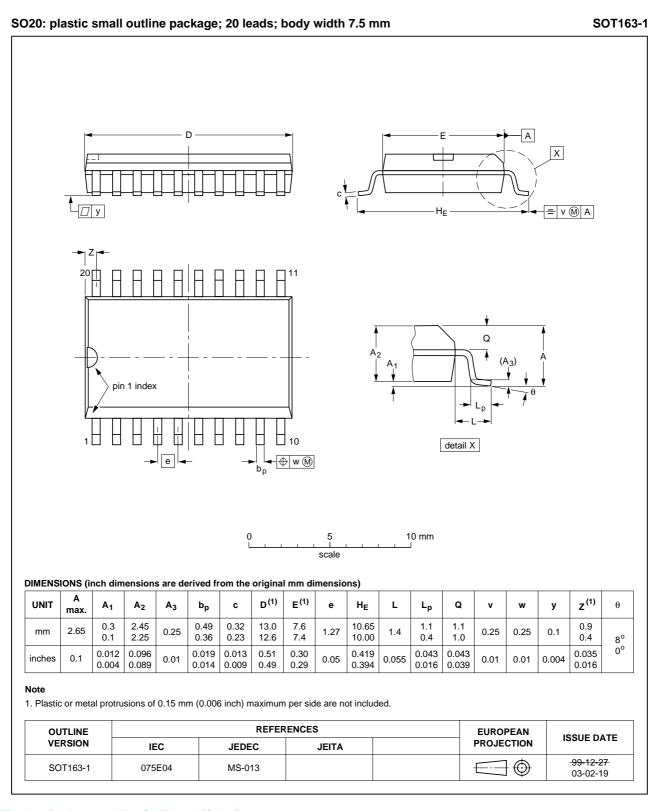


Fig 13. Package outline SOT163-1 (SO20)

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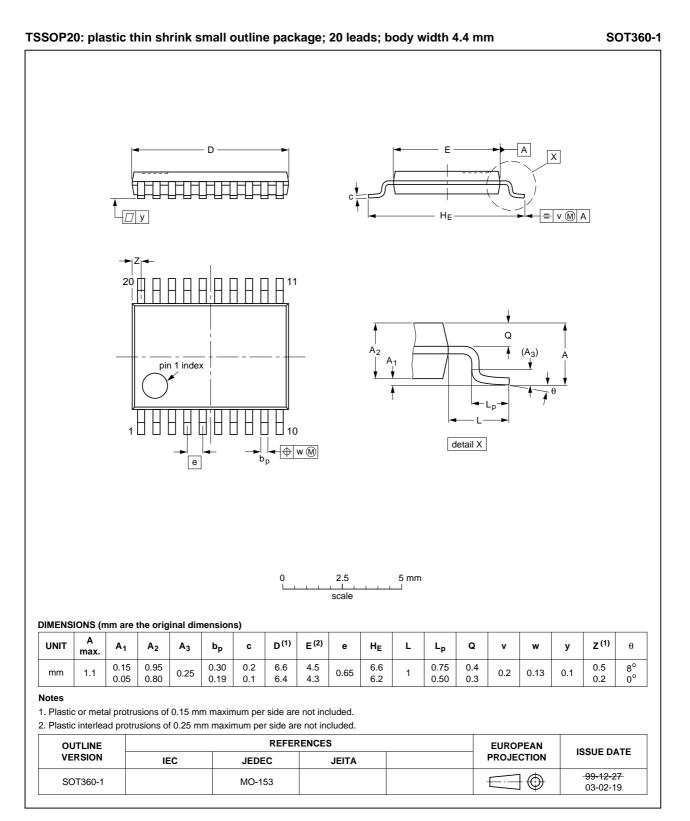


Fig 14. Package outline SOT360-1 (TSSOP20)

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14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4894B v.8	20111122	Product data sheet	-	HEF4894B v.7
Modifications:	 Section App 	olications removed		
	• <u>Table 6</u> : I _{OH}	minimum values changed to	o maximum	
HEF4894B v.7	20100813	Product data sheet	-	HEF4894B v.6
HEF4894B v.6	20100408	Product data sheet	-	HEF4894B v.5
HEF4894B v.5	20091222	Product data sheet	-	HEF4894B v.4
HEF4894B v.4	20080827	Product data sheet	-	HEF4894B_CNV v.3
HEF4894B_CNV v.3	19950101	Product specification	-	HEF4894B_CNV v.2
HEF4894B_CNV v.2	19950101	Product specification	-	-

12-stage shift-and-store register LED driver

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

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